

IGBT - Power, Co-PAK N-Channel, Field Stop IV, MQ (Medium Speed), TO247-4L 650 V, 1.45 V, 75 A FGH4L75T65MQDC50

Using the novel field stop 4th generation IGBT technology and generation 1.5 SiC Schottky Diode technology in TO-247 4-lead package, FGH4L75T65MQDC50 offers the optimum performance with both low conduction and switching losses for high-efficiency operations in various applications, especially totem pole bridgeless PFC and Inverter.

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- Positive Temperature Coefficient for Easy Parallel Operation
- High Current Capability
- 100% of the Parts are Tested for I_{LM} (Note 2)
- Smooth and Optimized Switching
- Low Saturation Voltage: $V_{CE(Sat)} = 1.45 \text{ V (Typ.)}$ @ $I_C = 75 \text{ A}$
- No Reverse Recovery / No Forward Recovery
- Tight Parameter Distribution
- RoHS Compliant

Applications

- Charging Station (EVSE)
- Solar Inverter

• UPS, ESS

• PFC, Converters

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

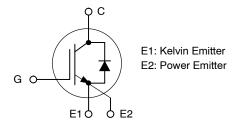
Parame	Symbol	Value	Unit	
Collector-to-Emitter Voltage		V _{CES}	650	V
Gate-to-Emitter Voltage		V_{GES}	±20	
Transient Gate-to-Emitter $(t_p < 0.5 \mu s, D < 0.001)$	Voltage		±30	
Collector Current	T _C = 25°C (Note 1)	Ic	110	Α
	T _C = 100°C		75	
Power Dissipation	T _C = 25°C	P_{D}	385	W
	T _C = 100°C		192	
Pulsed Collector Current	Pulsed Collector Current T _C = 25°C (Note 2)		300	Α
T _C = 25°C (Note 3)		I _{CM}	300	
Diode Forward Current T _{C =} 25°C (Note 1)		Ι _F	60	Α
	$T_{C} = 100^{\circ}C$		50	
Pulsed Diode Maximum $T_{C = 25^{\circ}C}$ Forward Current		I _{FM}	200	Α
Operating Junction and Storage Temperature Range		T _J , T _{STG}	−55 to +175	°C
Maximum Lead Temperature for Soldering Purposes		TL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Value limit by bond wire
- 2. V_{CC} = 400 \acute{V} , V_{GE} = 15 \acute{V} , I_{C} = 300 \acute{A} , Inductive Load, 100% tested
- 3. Repetitive rating: pulse width limited by max. junction temperature

BV _{CES}	V _{CE(sat)}	lc
650 V	1.45 V	75 A

PIN CONNECTIONS





TO-247-4LD CASE 340CJ

MARKING DIAGRAM



\$Y = onsemi Logo &Z = Assembly Plant Code &3 = 3-Digit Date Code &K = 2-Digit Lot Traceability Code G75T65MQDC50 = Specific Device Code

ORDERING INFORMATION

Device	Package	Shipping
FGH4L75T65MQDC50	TO-247	30 Units / Tube
	-4LD	

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Resistance Junction-to-Case, for IGBT	$R_{ heta JC}$	0.39	°C/W
Thermal Resistance Junction-to-Case, for Diode	$R_{ heta JCD}$	0.74	
Thermal Resistance Junction-to-Ambient	$R_{ hetaJA}$	40	

	J = 25°C unless otherwise noted)		1	T -	Г	T
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS		1	•	1	1	
Collector-emitter Breakdown Voltage, Gate-emitter Short-circuited	$V_{GE} = 0 \text{ V, I}_{C} = 1 \text{ mA}$	BV _{CES}	650	-	-	V
Temperature Coefficient of Breakdown Voltage	V _{GE} = 0 V, I _C = 1 mA	$\frac{\Delta BV_{CES}}{\Delta T_{J}}$	-	0.5	-	V/°C
Collector-emitter Cut-off Current, Gate-emitter Short-circuited	V _{GE} = 0 V, V _{CE} = 650 V	I _{CES}	-	-	250	μА
Gate Leakage Current, Collector-emitter Short-circuited	V _{GE} = 20 V, V _{CE} = 0 V	I _{GES}	_	-	±400	nA
ON CHARACTERISTICS						
Gate-emitter Threshold Voltage	$V_{GE} = V_{CE}$, $I_C = 75 \text{ mA}$	V _{GE(th)}	3.0	4.5	6.0	V
Collector-emitter Saturation Voltage	V _{GE} = 15 V, I _C = 75 A, T _J = 25°C	V _{CE(sat)}	-	1.45	1.8	V
	V _{GE} = 15 V, I _C = 75 A, T _J = 175°C		-	1.65	_	1
DYNAMIC CHARACTERISTICS						
Input Capacitance	V _{CE} = 30 V, V _{GE} = 0 V, f = 1 MHz	C _{ies}	-	4770	_	pF
Output Capacitance		C _{oes}	-	619	_]
Reverse Transfer Capacitance		C _{res}	-	13	_	1
Gate Charge Total	V _{CC} = 400 V, I _C = 75 A, V _{GE} = 15 V	Q_g	-	146	_	nC
Gate-to-emitter Charge		Q _{ge}	-	26	_	1
Gate-to-collector Charge		Q _{gc}	-	34	_	1
SWITCHING CHARACTERISTICS, INDUC	TIVE LOAD					
Turn-on Delay Time	T _J = 25°C, V _{CC} = 400 V,	t _{d(on)}	-	24	_	ns
Rise Time	I_C = 37.5 A, R_G = 10 Ω , V_{GE} = 15 V, Inductive Load	t _r	-	16	_	1
Turn-off Delay Time		t _{d(off)}	-	192	-	1
Fall Time		t _f	-	16	_	
Turn-on Switching Loss		E _{on}	-	0.31	-	mJ
Turn-off Switching Loss		E _{off}	-	0.49	-	1
Total Switching Loss		E _{ts}	-	0.81	_	1
Turn-on Delay Time	T _J = 25°C, V _{CC} = 400 V,	t _{d(on)}	-	29	_	ns
Rise Time	I_C = 75 A, R_G = 10 Ω , V_{GE} = 15 V, Inductive Load	t _r	-	27	_	1
Turn-off Delay Time		t _{d(off)}	-	187	-	1
Fall Time		t _f	-	18	-	1
Turn-on Switching Loss		E _{on}	-	0.72	-	mJ
Turn-off Switching Loss		E _{off}	-	0.96	-	1
Total Switching Loss		E _{ts}	-	1.68	_	1

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted) (continued)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS,	INDUCTIVE LOAD			-		
Turn-on Delay Time	T _J = 175°C, V _{CC} = 400 V,	t _{d(on)}	-	24	-	ns
Rise Time	I_C = 37.5 A, R_G = 15 Ω , V_{GE} = 10 V, Inductive Load	t _r	-	20	-	1
Turn-off Delay Time		t _{d(off)}	-	220	-	1
Fall Time		t _f	-	72	-	1
Turn-on Switching Loss		E _{on}	-	0.41	-	mJ
Turn-off Switching Loss		E _{off}	-	0.82	-	1
Total Switching Loss		E _{ts}	-	1.23	-	1
Turn-on Delay Time	$T_J = 175^{\circ}C$, $V_{CC} = 400 \text{ V}$,	t _{d(on)}	-	27	-	ns
Rise Time	I_C = 75 A, R_G = 15 Ω, V_{GE} = 10 V, Inductive Load	t _r	-	34	-	1
Turn-off Delay Time		t _{d(off)}	-	202	-	1
Fall Time		t _f	-	54	-	
Turn-on Switching Loss		E _{on}	-	0.91	-	mJ
Turn-off Switching Loss		E _{off}	-	1.30	-	
Total Switching Loss		E _{ts}	-	2.20	-	
DIODE CHARACTERISTICS	•			-		
Diode Forward Voltage	I _F = 50 A, T _J = 25°C	V _F	-	1.46	1.7	V
	I _F = 50 A, T _J = 175°C	1	-	1.83	-	1
Total Capacitance	V _R = 400 V, f = 1 MHz, T _J = 25°C	С	-	210	-	pF
	V _R = 600 V, f = 1 MHz, T _J = 25°C		-	202	-	1

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS

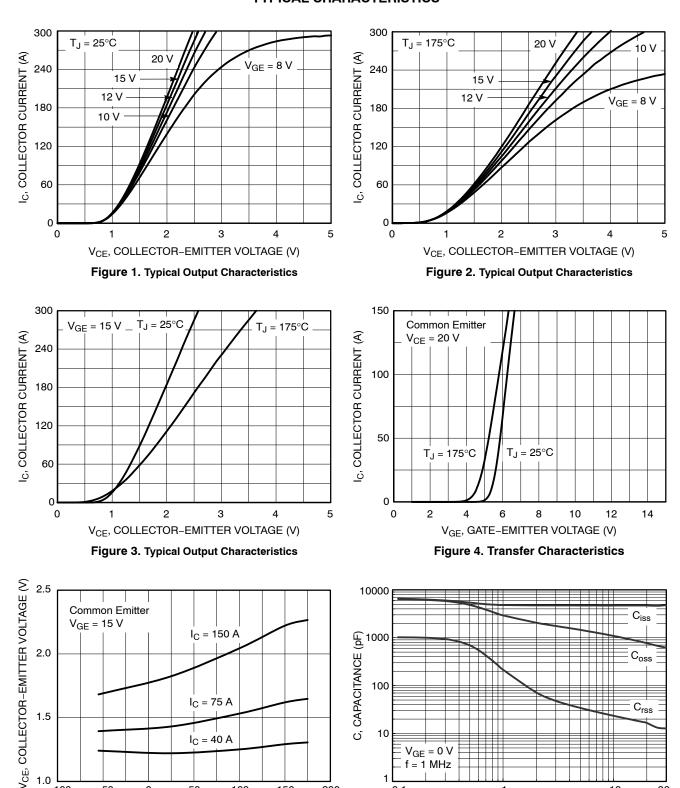


Figure 5. Saturation Voltage vs. Junction **Temperature at Various Current Level**

50

T_J, COLLECTOR-EMITTER JUNCTION TEMPERATURE (°C)

1.0

-100

-50

0

 $I_{C} = 40 \text{ A}$

100

150

V_{CE}, COLLECTOR-EMITTER VOLTAGE (V) Figure 6. Capacitance Variation

 $V_{GE} = 0 V$ f = 1 MHz

200

TYPICAL CHARACTERISTICS

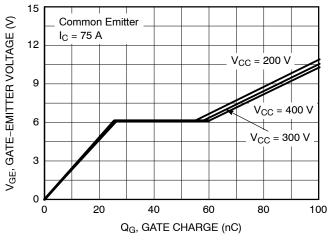


Figure 7. Gate Charge Characteristics

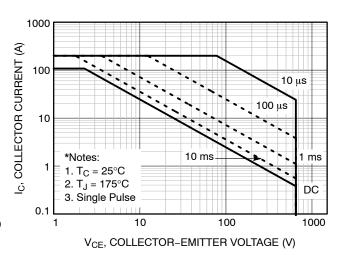


Figure 8. SOA Characteristics

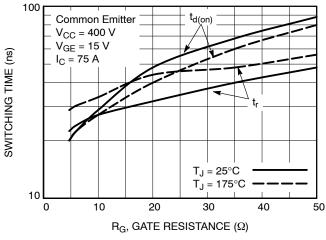


Figure 9. Turn-On Characteristics vs. Gate Resistance

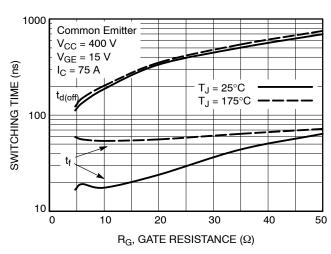


Figure 10. Turn-Off Characteristics vs. Gate Resistance

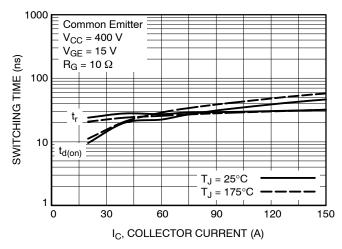


Figure 11. Turn-on Characteristics vs.
Collector Current

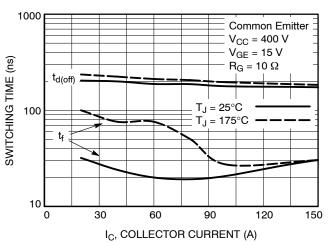


Figure 12. Turn-Off Characteristics vs.
Collector Current

TYPICAL CHARACTERISTICS

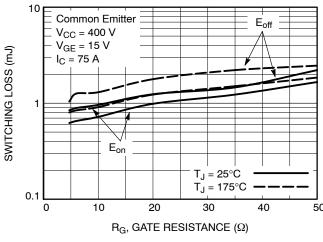


Figure 13. Switching Loss vs. Gate Resistance

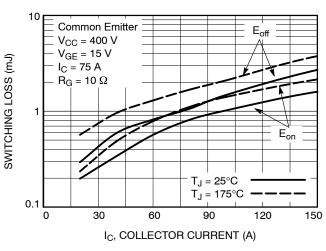


Figure 14. Switching Loss vs. Collector Current

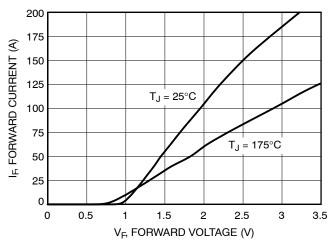


Figure 15. Forward Diode Characteristics

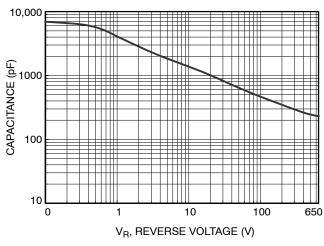


Figure 16. (Diode) Output Capacitance (Coes) vs. Reverse Voltage

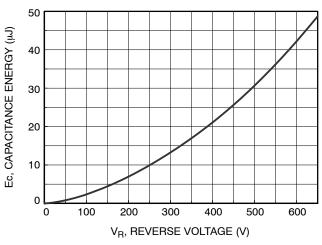


Figure 17. Output Capacitance Stored Energy

TYPICAL CHARACTERISTICS

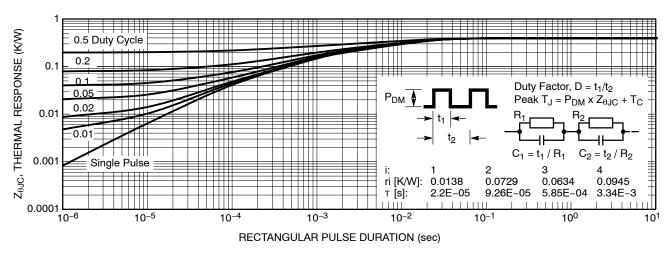


Figure 18. Transient Thermal Impedance of IGBT

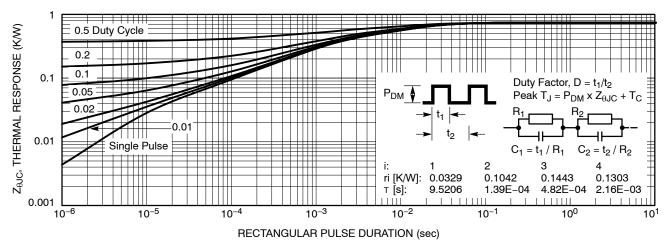
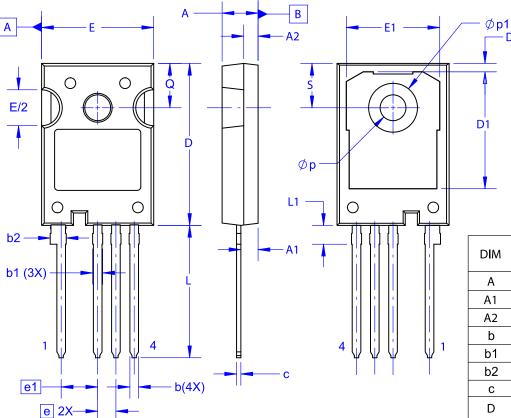


Figure 19. Transient Thermal Impedance of Diode

TO-247-4LD CASE 340CJ **ISSUE A**

DATE 16 SEP 2019

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NOTES:

0.254 M

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 C. ALL DIMENSIONS ARE IN MILLIMETERS.

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D. DRAWING CONFORMS TO ASME Y14.5-2009.

DIM	WILLIMIETERS			
DIM	MIN	NOM	MAX	
Α	4.80	5.00	5.20	
A1	2.10	2.40	2.70	
A2	1.80	2.00	2.20	
b	1.07	1.20	1.33	
b1	1.20	1.40	1.60	
b2	2.02	2.22	2.42	
С	0.50	0.60	0.70	
D	22.34	22.54	22.74	
D1	16.00	16.25	16.50	
D2	0.97	1.17	1.37	
е	2	2.54 BSC		
e1	Ę	5.08 BSC		
E	15.40	15.60	15.80	
E1	12.80	13.00	13.20	
E/2	4.80	5.00	5.20	
L	18.22	18.42	18.62	
L1	2.42	2.62	2.82	
р	3.40	3.60	3.80	
p1	6.60	6.80	7.00	
Q	5.97	6.17	6.37	
S	5.97	6.17	6.37	

MILLIMETERS

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